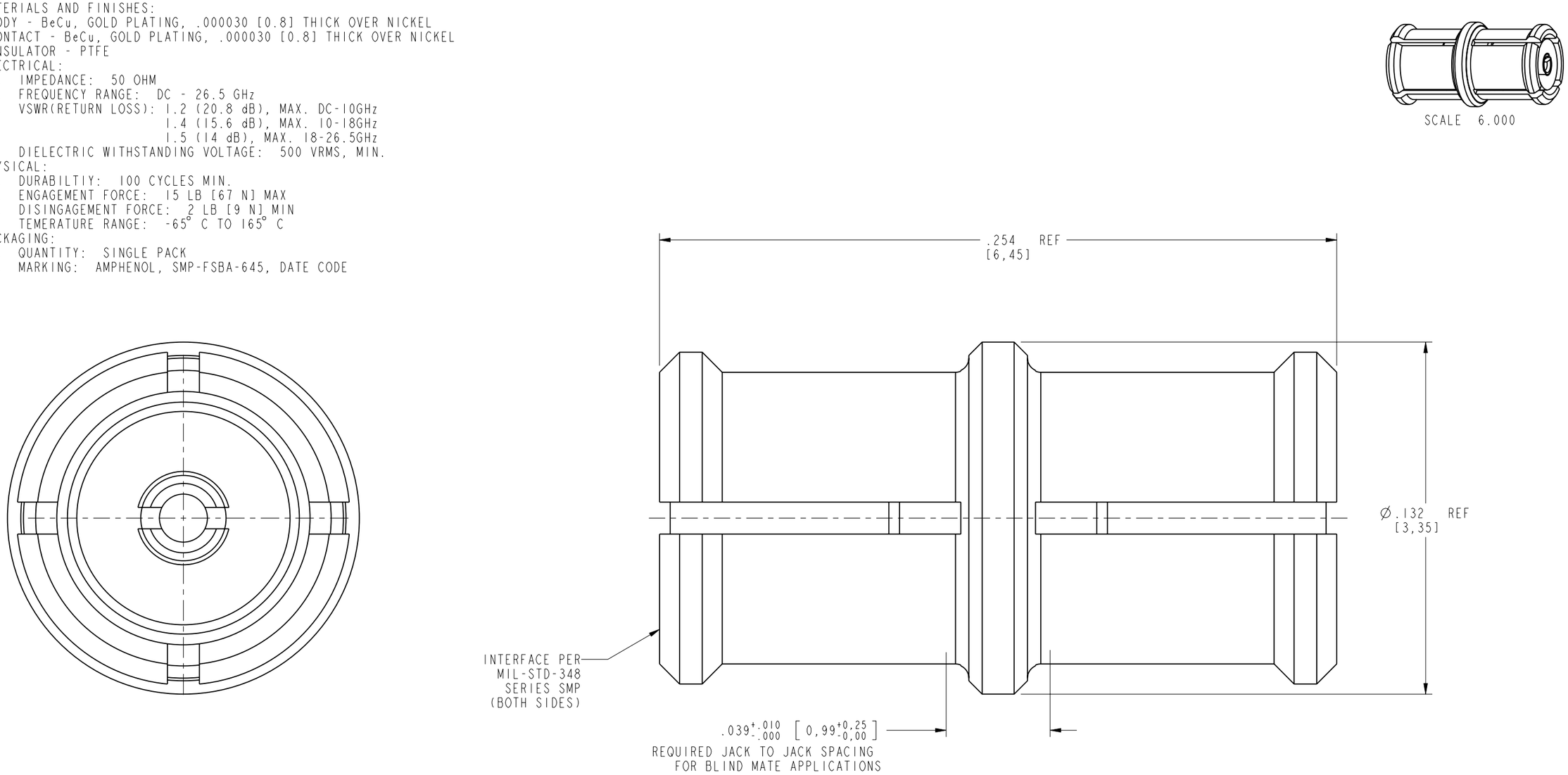
| SMP-FSBA-645 | REVISIONS | | | | |
|---|---|---|---|---|---|
| DRAWING NO. | REV | DESCRIPTION | DATE | ECO | APPR |
| THIRD ANGLE PROJ. | A | RELEASE TO MFG | 2/25/05 | 45416 | |

NOTES:
1. MATERIALS AND FINISHES:
   BODY - BeCu, GOLD PLATING, .000030 [0.8] THICK OVER NICKEL
   CONTACT - BeCu, GOLD PLATING, .000030 [0.8] THICK OVER NICKEL
   INSULATOR - PTFE
2. ELECTRICAL:
   A. IMPEDANCE: 50 OHM
   B. FREQUENCY RANGE: DC - 26.5 GHz
   C. VSWR(RETURN LOSS): 1.2 (20.8 dB), MAX. DC-10GHz
      1.4 (15.6 dB), MAX. 10-18GHz
      1.5 (14 dB), MAX. 18-26.5GHz
   D. DIELECTRIC WITHSTANDING VOLTAGE: 500 VRMS, MIN.
3. PHYSICAL:
   A. DURABILTIY: 100 CYCLES MIN.
   B. ENGAGEMENT FORCE: 15 LB [67 N] MAX
   C. DISINGAGEMENT FORCE: 2 LB [9 N] MIN
   E. TEMERATURE RANGE: -65° C TO 165° C
4. PACKAGING:
   A. QUANTITY: SINGLE PACK
   B. MARKING: AMPHENOL, SMP-FSBA-645, DATE CODE








SCALE 6.000

CUSTOMER OUTLINE DRAWING
ALL OTHER SHEETS ARE FOR INTERNAL USE ONLY

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN INCHES AND TOLERANCES ARE:
2 PLACE DECIMAL ±.015 (0,381 mm) | 3 PLACE DECIMAL ±.005 (0,127 mm) | ANGLES ± 1°

NOTICE - These drawings, specifications, or other data (1) are, and remain the property of Amphenol Corp. (2) must be returned upon request; and (3) are confidential and not to be disclosed to any person other than those to whom they are given by Amphenol Corp. The furnishing of these drawings, specifications, or other data by Amphenol Corp., or to any other person to anyone for any purpose is not to be regarded by implication or otherwise in any manner licensing, granting rights or permitting such holder or any other person to manufacture, use or sell any product, process or design, patented or otherwise, that may in any way be related to or disclosed by said drawings, specifications, or other data.

MATERIAL

REFERENCE
GEN# ASSYF4_SMP
EAR# 796, PREVIOUSLY 322 &1693
615X-1718-100

| | | |
|---|---|---|
| DRAWN | MIKE HOYACK | DATE 10-Dec-02 |
| ENGINEER | MIKE HOYACK | DATE 10-Dec-02 |
| APPROVED | OWEN BARTHELMES | DATE 2/23/05 |
| CAD FILE | I:\SMP\SMP-FSBA-645 | |

TITLE
ASSEMBLY
FEMALE TO FEMALE

Amphenol RF
Danbury, CT, USA
Tainan, Taiwan
Shenzhen, China
www.amphenolrf.com

SCALE: 25.0:1 | SHEET 2 OF 2

| CODE ID | DWG SIZE | DRAWING NO. | REV |
|---|---|---|---|
| 74868 | B | SMP-FSBA-645 | A |